## IAP16 Rec'd PCT/PTO 18 SEP 2006 10/593137

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Appl. No. Applicant(s)

Filed Herewith OKUBO, et al. : Filed Herewith

TC/A.U. Examiner

**TBA** : TBA

Title

Filed

: RESIN COMPOSITION AND SEMICONDUCTOR DEVICE

PRODUCED BY USING THE SAME

Docket No.

033036.110

Customer No. : 25461

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Sir:

## PRELIMINARY AMENDMENT

Preliminary to the examination of the above identified application, please enter the following amendment.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 13 of this paper.